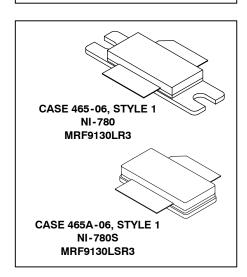
# The RF Sub-Micron MOSFET Line **RF Power Field Effect Transistors**N-Channel Enhancement-Mode Lateral MOSFETs

Designed for GSM and GSM EDGE base station applications with frequencies from 921 to 960 MHz, the high gain and broadband performance of these devices make them ideal for large-signal, common-source amplifier applications in 28 volt base station equipment.

- Typical Performance for GSM Frequencies, 921 to 960 MHz, 28 Volts
   Output Power @ P1dB 135 Watts
   Power Gain 16.5 dB @ 130 Watts Output Power
   Efficiency 48% @ 130 Watts Output Power
- Internally Matched, Controlled Q, for Ease of Use
- · High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 5:1 VSWR, @ 28 Vdc, All Frequency Band, 130 Watts CW Output Power
- Excellent Thermal Stability
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- Low Gold Plating Thickness on Leads, 40μ" Nominal.
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 inch Reel.

## MRF9130LR3 MRF9130LSR3

GSM/GSM EDGE 921-960 MHz, 130 W, 28 V LATERAL N-CHANNEL RF POWER MOSFETs



#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	65	Vdc
Gate-Source Voltage	$V_{GS}$	- 0.5, +15	Vdc
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	298 1.7	Watts W/°C
Storage Temperature Range	T <sub>stg</sub>	- 65 to +200	°C
Operating Junction Temperature	TJ	200	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case		0.6	°C/W

#### **ESD PROTECTION CHARACTERISTICS**

Test Conditions	Class
Human Body Model	1 (Minimum)
Machine Model	M2 (Minimum)
Charge Device Model	C7 (Minimum)

NOTE - <u>CAUTION</u> - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

MOTOROLA intelligence everywhere



#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic		Min	Тур	Max	Unit
FF CHARACTERISTICS	•		•	•	•
Zero Gate Voltage Drain Leakage Current (V <sub>DS</sub> = 65 Vds, V <sub>GS</sub> = 0 Vdc)	I <sub>DSS</sub>	_	_	10	μAdc
Zero Gate Voltage Drain Leakage Current (V <sub>DS</sub> = 28 Vds, V <sub>GS</sub> = 0 Vdc)	I <sub>DSS</sub>	_	_	1	μAdc
Gate-Source Leakage Current (V <sub>GS</sub> = 5 Vdc, V <sub>DS</sub> = 0 Vdc)		_	_	1	μAdc
N CHARACTERISTICS					•
Gate Threshold Voltage ( $V_{DS}$ = 10 Vdc, $I_{D}$ = 450 $\mu$ Adc)	V <sub>GS(th)</sub>	2	3	4	Vdc
Gate Quiescent Voltage (V <sub>DS</sub> = 28 Vdc, I <sub>D</sub> = 1000 mAdc)	V <sub>GS(Q)</sub>	_	3.6	_	Vdc
Drain-Source On-Voltage (V <sub>GS</sub> = 10 Vdc, I <sub>D</sub> = 3 Adc)	V <sub>DS(on)</sub>	=	0.2	0.4	Vdc
Forward Transconductance (V <sub>DS</sub> = 10 Vdc, I <sub>D</sub> = 9 Adc)	9fs	_	12	_	S
YNAMIC CHARACTERISTICS (1)	•			•	
Output Capacitance $(V_{DS} = 28 \text{ Vdc} \pm 30 \text{ mV(rms)ac} @ 1 \text{ MHz}, V_{GS} = 0 \text{ Vdc})$	C <sub>oss</sub>	=	110	_	pF
Reverse Transfer Capacitance $(V_{DS} = 28 \text{ Vdc} \pm 30 \text{ mV(rms)ac} @ 1 \text{ MHz}, V_{GS} = 0 \text{ Vdc})$	C <sub>rss</sub>	_	4.4	_	pF
UNCTIONAL TESTS (In Motorola Test Fixture)		-			•
Power Output, 1 dB Compression Point (V <sub>DD</sub> = 28 Vdc, I <sub>DQ</sub> = 1000 mA, f = 921 and 960 MHz)	P1dB	120	135	_	W
Common-Source Amplifier Power Gain $(V_{DD} = 28 \text{ Vdc}, P_{out} = 130 \text{ W}, I_{DQ} = 1000 \text{ mA}, f = 921 \text{ and } 960 \text{ MHz})$	G <sub>ps</sub>	15.5	16.5	_	dB
Drain Efficiency $(V_{DD} = 28 \text{ Vdc}, P_{out} = 130 \text{ W}, I_{DQ} = 1000 \text{ mA}, f = 921 \text{ and } 960 \text{ MHz})$	η	43	48	_	%
Input Return Loss (V <sub>DD</sub> = 28 Vdc, P <sub>out</sub> = 130 W, I <sub>DQ</sub> = 1000 mA, f = 921 and 960 MHz)	IRL	_	-12	-9	dB
Output Mismatch Stress (V <sub>DD</sub> = 28 Vdc, P <sub>out</sub> = 130 W CW, I <sub>DQ</sub> = 1000 mA, f = 921 MHz, VSWR = 5:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power Before and After Test			

<sup>(1)</sup> Part is internally input matched.

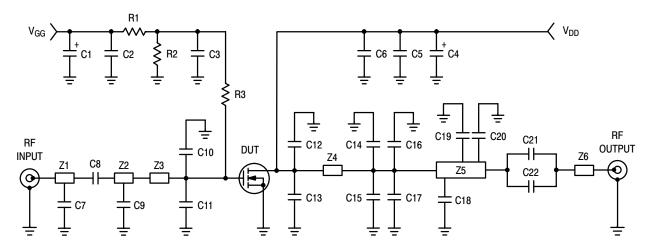


Figure 1. 921-960 MHz Test Circuit Schematic

Table 1. 921-960 MHz Test Circuit Component Designations and Values

Designators	Description
C1, C4	10 μF, 35 V Tantalum Capacitors, Vishay-Sprague #293D106X9035D
C2, C5	100 nF Chip Capacitors (1206), AVX #1206C104KATDA
C3, C8, C21, C22	22 pF, 100B Chip Capacitors, ATC #100B220C
C6	33 pF, 100B Chip Capacitor, ATC #100B330JW
C7	1.0 pF, 100B Chip Capacitor, ATC #100B1R0BW
C9	4.7 pF, 100B Chip Capacitor, ATC #100B4R7BW
C10	8.2 pF, 100B Chip Capacitor, ATC #100B8R2CW
C11	10 pF, 100B Chip Capacitor, ATC #100B100GW
C12, C13	12 pF, 100B Chip Capacitors, ATC #100B120GW
C14, C15	2.7 pF, 100B Chip Capacitors, ATC #100B2R7BW
C16, C17, C18	3.9 pF, 100B Chip Capacitors, ATC #100B3R9BW
C19	3.3 pF, 100B Chip Capacitor, ATC #100B3R3BW
C20	1.8 pF, 100B Chip Capacitor, ATC #100B1R8BW
R1	18 kΩ, 1/8 W Chip Resistor (1206)
R2	10 kΩ, 1/8 W Chip Resistor (1206)
R3	1.0 kΩ, 1/8 W Chip Resistor (1206)
Z1	0.117" x 0.600" Microstrip
Z2	0.117" x 1.851" Microstrip
Z3	1.074" x 1.068" Microstrip
Z4	1.074" x 0.980" Microstrip
<b>Z</b> 5	0.117" x 1.933" Microstrip
<b>Z</b> 6	0.117" x 0.605" Microstrip
PCB	Taconic TLX8, 0.030", $\varepsilon_{r}$ = 2.55

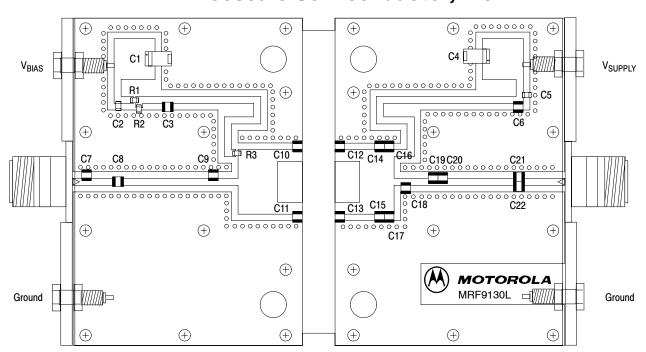


Figure 2. 921-960 MHz Test Circuit Component Layout

#### **TYPICAL CHARACTERISTICS**

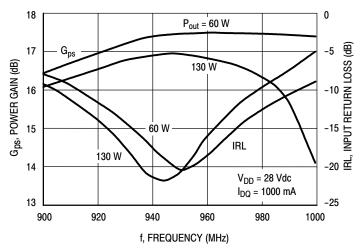


Figure 3. Power Gain and Input Return Loss versus Frequency

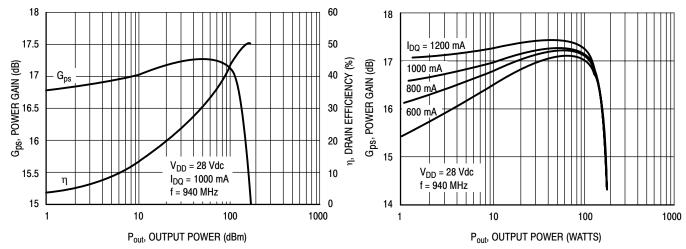


Figure 4. Power Gain and Efficiency versus
Output Power

Figure 5. Power Gain versus Output Power

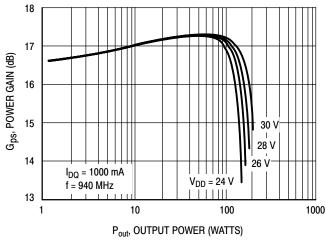


Figure 6. Power Gain versus Output Power

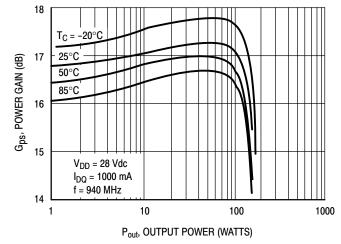


Figure 7. Power Gain versus Output Power

#### **TYPICAL CHARACTERISTICS**

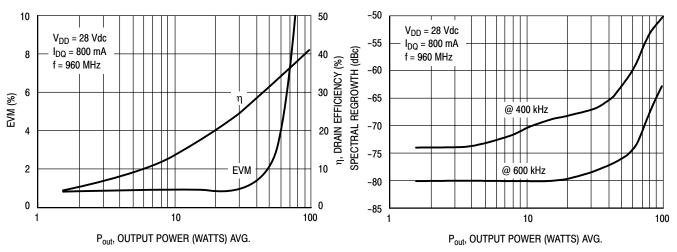
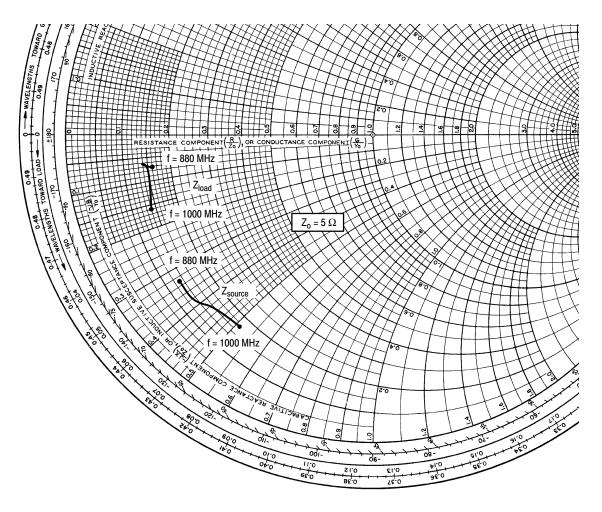


Figure 8. EVM and Efficiency versus Output **Power** 

Figure 9. Spectral Regrowth versus Output Power

NOTE: Curves on Figure 8 and 9 gathered on a GSM EDGE optimized text fixture.



 $V_{DD}$  = 28 Vdc,  $I_{DQ}$  = 1000 mA,  $P_{out}$  = 130 W CW

f MHz	$\mathbf{Z_{source}}_{\Omega}$	$\mathbf{Z_{load}}_{\Omega}$
880	0.63 - j1.66	0.82 - j0.36
920	0.67 - j1.88	0.72 - j0.30
960	0.82 - j2.18	0.74 - j0.37
1000	0.86 - j2.56	0.69 - j0.79

 $Z_{\text{source}}$  = Test circuit impedance as measured from gate to ground.

Z<sub>load</sub> = Test circuit impedance as measured from drain to ground.

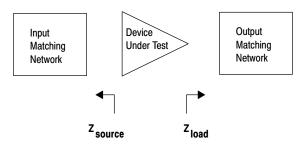
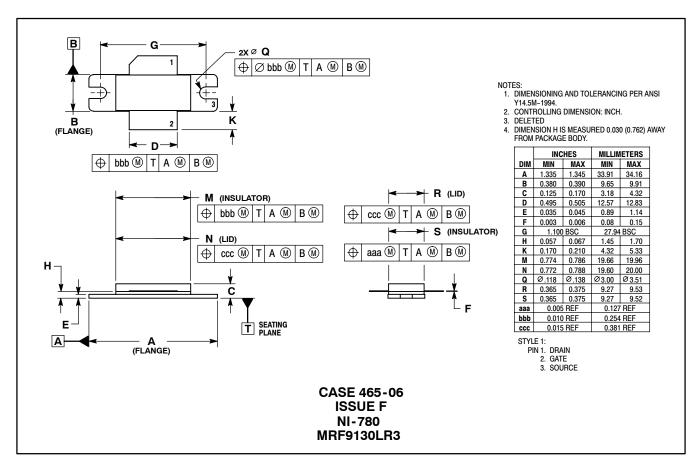
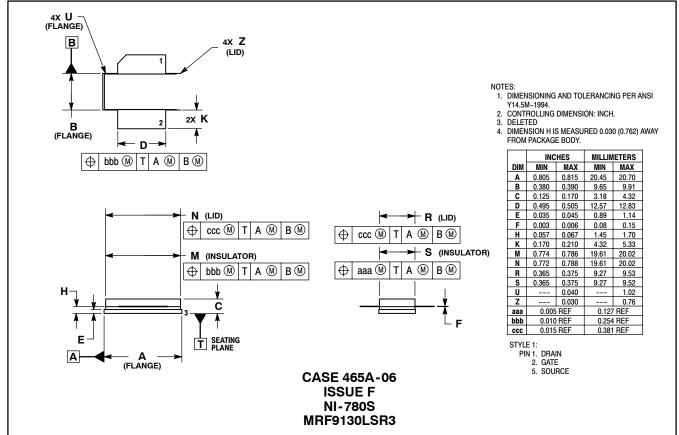


Figure 10. Series Equivalent Input and Output Impedance

#### **PACKAGE DIMENSIONS**





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